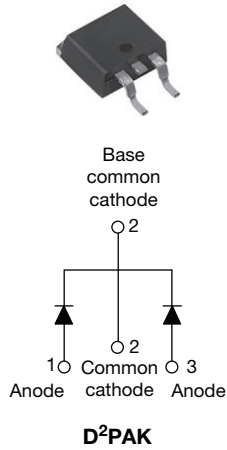
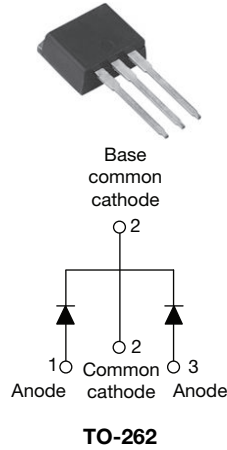


## Schottky Rectifier, 2 x 20 A

**VS-MBRB4045CTHM3**

**VS-MBR4045CT-1HM3**


### FEATURES

- 150 °C  $T_J$  operation
- Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 1A whisker test
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**

### PRODUCT SUMMARY

Package	TO-263AB (D <sup>2</sup> PAK), TO-262AA
$I_{F(AV)}$	2 x 20 A
$V_R$	45 V
$V_F$ at $I_F$	0.58 V
$I_{RM}$ max.	95 mA at 125 °C
$T_J$ max.	150 °C
Diode variation	Common cathode
$E_{AS}$	20 mJ

### DESCRIPTION

The center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

### MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Rectangular waveform (per device)	40	A
$I_{FRM}$	$T_C = 117$ °C (per leg)	40	
$V_{RRM}$		45	V
$I_{FSM}$	$t_p = 5$ $\mu$ s sine	900	A
$V_F$	20 $A_{pk}$ , $T_J = 125$ °C	0.58	V
$T_J$	Range	-65 to 150	°C

### VOLTAGE RATINGS

PARAMETER	SYMBOL	VS-MBRB4045CTHM3 VS-MBR4045CT-1HM3	UNITS
Maximum DC reverse voltage	$V_R$	45	V
Maximum working peak reverse voltage	$V_{RWM}$		

### ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current _____ per leg per device	$I_{F(AV)}$	$T_C = 118$ °C, rated $V_R$	20	A
			40	
Peak repetitive forward current per leg	$I_{FRM}$	Rated $V_R$ , square wave, 20 kHz, $T_C = 117$ °C	40	
Maximum peak one cycle non-repetitive peak surge current per leg	$I_{FSM}$	5 $\mu$ s sine or 3 $\mu$ s rect. pulse	Following any rated load condition and with rated $V_{RRM}$ applied	
		10 ms sine or 6 ms rect. pulse		210
Non-repetitive avalanche energy per leg	$E_{AS}$	$T_J = 25$ °C, $I_{AS} = 3$ A, $L = 4.4$ mH	20	mJ
Repetitive avalanche current per leg	$I_{AR}$	Current decaying linearly to zero in 1 $\mu$ s Frequency limited by $T_J$ maximum $V_A = 1.5 \times V_R$ typical	3	A



ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop	$V_{FM}^{(1)}$	20 A	$T_J = 25\text{ }^\circ\text{C}$	0.60	V
		40 A		0.80	
		20 A	$T_J = 125\text{ }^\circ\text{C}$	0.58	
		40 A		0.80	
Maximum instantaneous reverse current	$I_{RM}^{(1)}$	$T_J = 25\text{ }^\circ\text{C}$	Rated DC voltage	1	mA
		$T_J = 100\text{ }^\circ\text{C}$		50	
		$T_J = 125\text{ }^\circ\text{C}$		95	
Maximum junction capacitance	$C_T$	$V_R = 5\text{ }V_{DC}$ (test signal range 100 kHz to 1 MHz), $25\text{ }^\circ\text{C}$		900	pF
Typical series inductance	$L_S$	Measured from top of terminal to mounting plane		8.0	nH
Maximum voltage rate of change	dV/dt	Rated $V_R$		10 000	V/ $\mu$ s

**Note**(1) Pulse width < 300  $\mu$ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum junction temperature range	$T_J$			-65 to 150	$^\circ\text{C}$
Maximum storage temperature range	$T_{Stg}$			-65 to 175	
Maximum thermal resistance, junction to case per leg	$R_{thJC}$	DC operation		1.5	$^\circ\text{C}/\text{W}$
Typical thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, smooth and greased (Only for TO-220)		0.50	
Maximum thermal resistance, junction to ambient	$R_{thJA}$	DC operation (For D <sup>2</sup> PAK and TO-262)		50	
Approximate weight				2	g
				0.07	oz.
Mounting torque	minimum		Non-lubricated threads	6 (5)	kgf · cm (lbf · in)
	maximum			12 (10)	
Marking device		Case style D <sup>2</sup> PAK		MBRB4045CTH	
		Case style TO-262		MBR4045CT-1H	

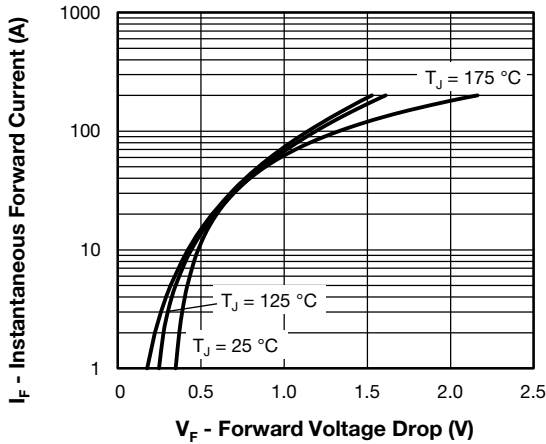


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

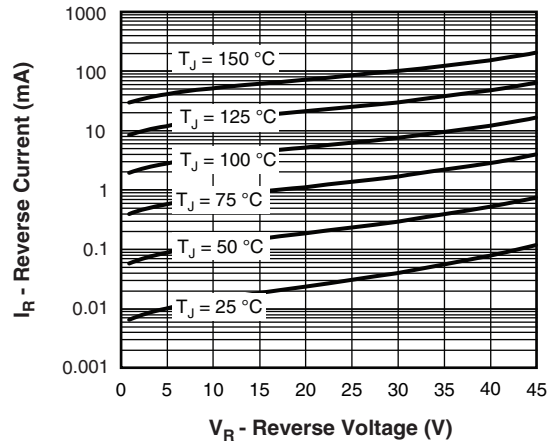


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

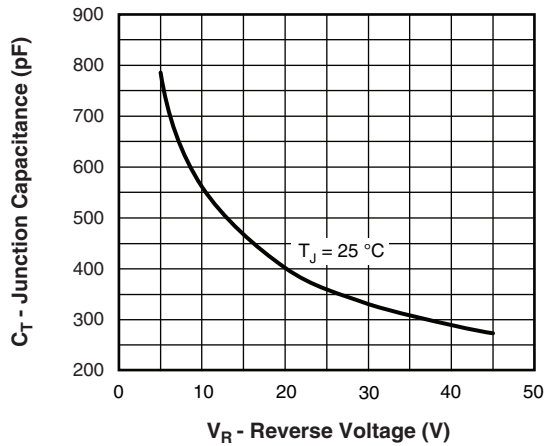


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

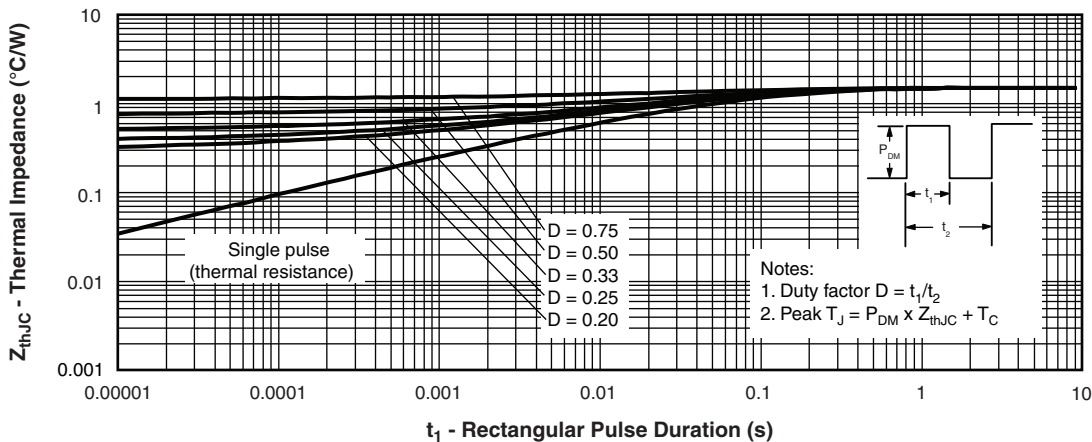


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Per Leg)

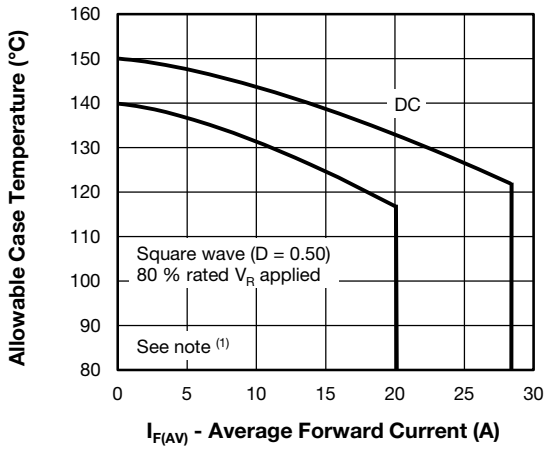


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

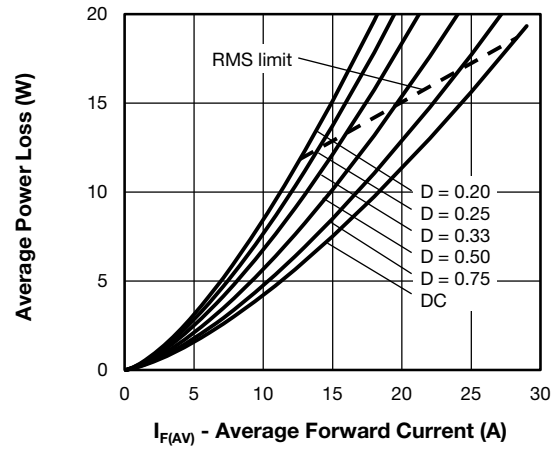


Fig. 6 - Forward Power Loss Characteristics

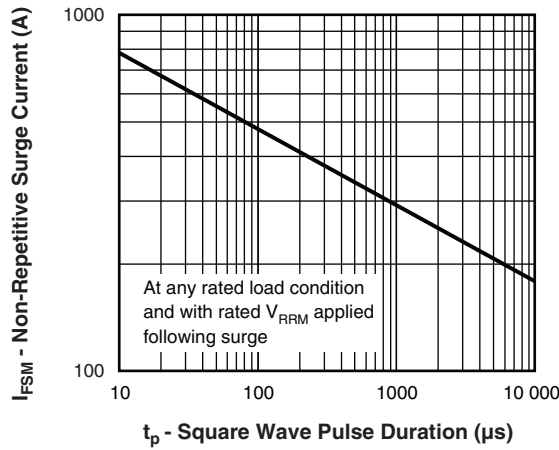


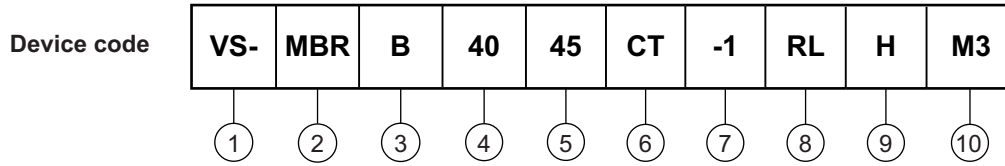
Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

**Note**

- (1) Formula used:  $T_C = T_J - (P_d + P_{d_{REV}}) \times R_{thJC}$ ;  
 $P_d$  = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);  
 $P_{d_{REV}}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = Rated  $V_R$



## ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Essential part number
- 3** -
  - B = D<sup>2</sup>PAK **7** None
  - None = TO-262 **7** = -1
- 4** - Current rating (40 = 40 A)
- 5** - Voltage rating (45 = 45 V)
- 6** - CT = Essential part number
- 7** -
  - None = D<sup>2</sup>PAK **3** = B
  - -1 = TO-262 **3** None
- 8** -
  - None = Tube
  - L = Tape and reel (left oriented - for D<sup>2</sup>PAK only)
  - R = Tape and reel (right oriented - for D<sup>2</sup>PAK only)
- 9** - H = AEC-Q101 qualified
- 10** - Environmental digit:  
M3 = Halogen-free, RoHS-compliant and termination lead (Pb)-free

ORDERING INFORMATION (Example)			
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-MBRB4045CTHM3	50	1000	Antistatic plastic tube
VS-MBR4045CT-1HM3	50	1000	Antistatic plastic tube
VS-MBRB4045CTLHM3	800	800	13" diameter reel
VS-MBRB4045CTRHM3	800	800	13" diameter reel

LINKS TO RELATED DOCUMENTS		
Dimensions	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95046">www.vishay.com/doc?95046</a>
	TO-262AA	<a href="http://www.vishay.com/doc?95419">www.vishay.com/doc?95419</a>
Part marking information	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95444">www.vishay.com/doc?95444</a>
	TO-262AA	<a href="http://www.vishay.com/doc?95443">www.vishay.com/doc?95443</a>
Packaging information	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95032">www.vishay.com/doc?95032</a>

## D<sup>2</sup>PAK

### DIMENSIONS in millimeters and inches

Conforms to JEDEC® outline D<sup>2</sup>PAK (SMD-220)



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.			MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190		D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010		E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039		E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4	e	2.54 BSC		0.100 BSC		
b2	1.14	1.78	0.045	0.070		H	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4	L	1.78	2.79	0.070	0.110	
c	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4	L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065		L3	0.25 BSC		0.010 BSC		
D	8.51	9.65	0.335	0.380	2	L4	4.78	5.28	0.188	0.208	

#### Notes

- Dimensioning and tolerancing per ASME Y14.5 M-1994
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- Thermal pad contour optional within dimension E, L1, D1 and E1
- Dimension b1 and c1 apply to base metal only
- Datum A and B to be determined at datum plane H
- Controlling dimension: inch
- Outline conforms to JEDEC® outline TO-263AB

## TO-262

**DIMENSIONS** in millimeters and inches

Modified JEDEC® outline TO-262



$\oplus 0.010 \text{ M} \text{ A} \text{ M} \text{ B}$



**Lead assignments**

- Diodes**  
 1. - Anode (two die)/open (one die)  
 2., 4. - Cathode  
 3. - Anode



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.36	3.71	0.132	0.146	

**Notes**

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum), D1 (minimum) and L2 where dimensions derived the actual package outline



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